

# HSP

**NOTES:**

Current Rating: 1.0AMP  
 Withstand Voltage: 500V AC/DC  
 Contact Resistance: 20mΩ Max  
 Insulation Resistance: 1000MΩMin  
 Operation Temperature: -40°C to +105°C

Contact Material: Phosphor Bronze  
 Contact plating: Au or Sn over Ni  
 Insulator Material: PA6T+30%G. F UL94V-0

## Ordering Information

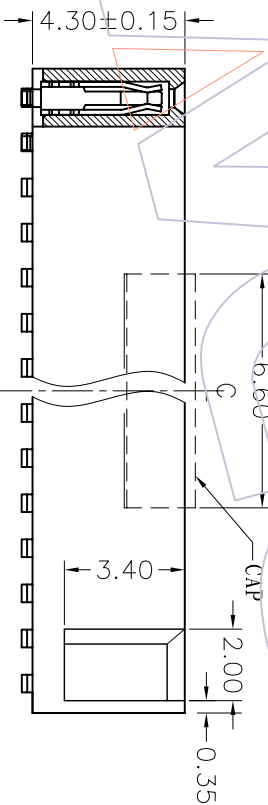
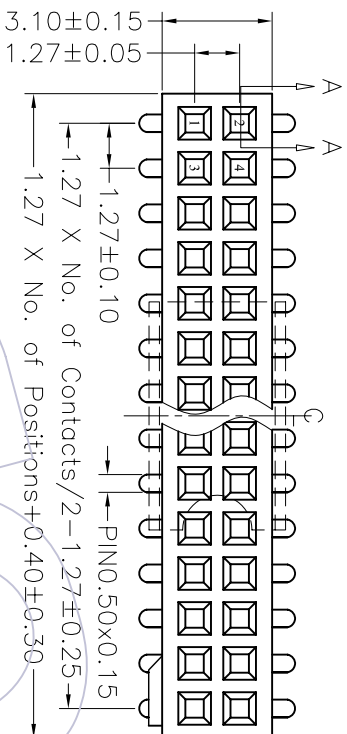
2344 - 2 XX M XX CUNT 5

No. of Pins per ROW: 02-50PIN

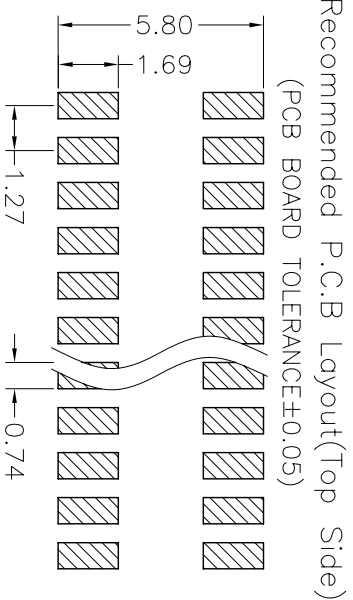
Contact Plating:  
 G0=Gold Flash  
 G1=3µ"Gold  
 G2=5µ"Gold  
 G3=10µ"Gold  
 G4=15µ"Gold  
 G5=30µ"Gold

Packing:  
 T=Tube  
 R=Tape&Reel+CAP  
 P=Tube+CAP

SI=3µ"Gold/Tin  
 S2=5µ"Gold/Tin  
 S3=10µ"Gold/Tin  
 S4=15µ"Gold/Tin  
 S5=30µ"Gold/Tin  
 SN=Tin

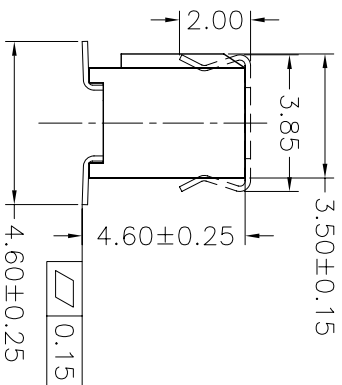


SECTION A-A



Recommended P.C.B Layout(Top Side)

(PCB BOARD TOLERANCE±0.05)



REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION		DRAW		SCALE		PART NO.	TITLE:	FH 1.27mm DUAL SMT H=4.30 WITH BUMP
					XXX	±0.40	DESIGN	UNIT	3:1	mm			
A0	08/02/16	NEW			XXX	±0.25	CHECK	A4	1/1	Customer NO.	2344-2XXMXXCUNT5		
					Angle	± 3'	APPROVE						

**WCON** 维峰五金电子有限公司  
 WAVE HARDWARE ELECTRONICS CO.,LTD